
Spectral and image analysis

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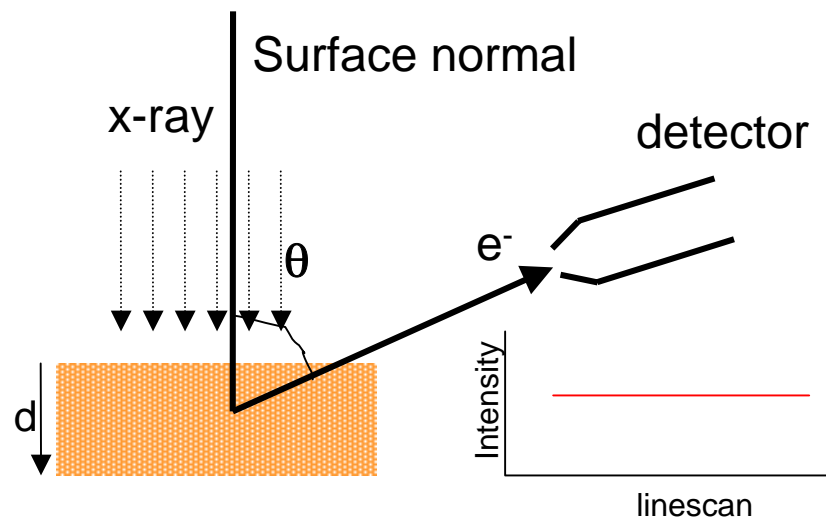
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Contrast mechanisms in a photoemission image

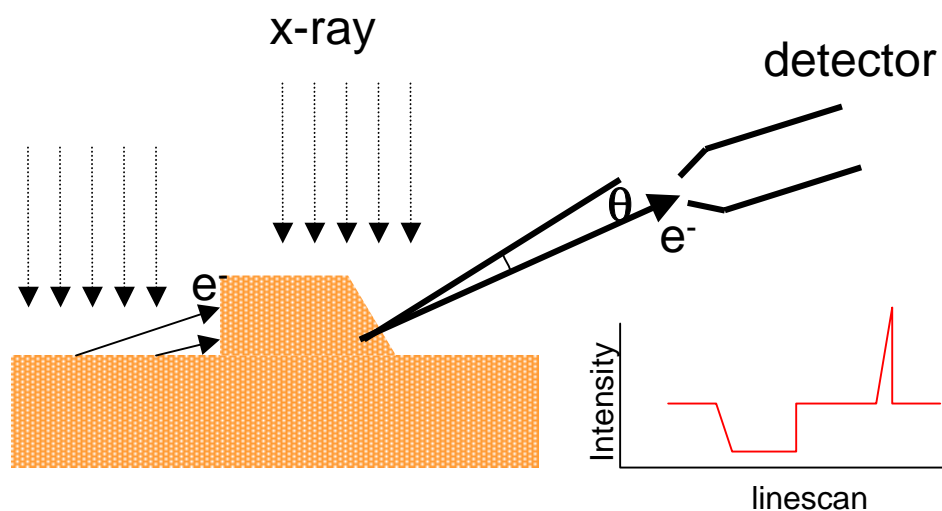
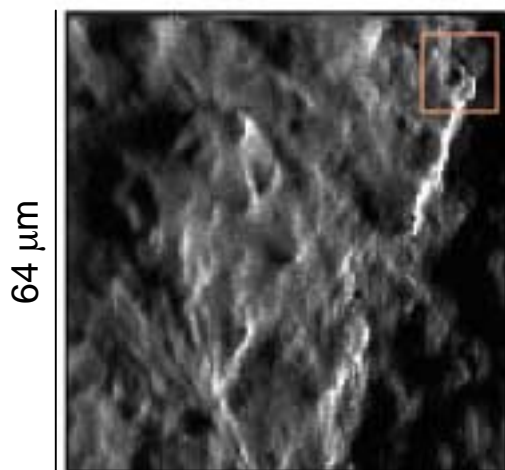
- Topography

$$I = I_0 e^{-\frac{d}{\lambda \cos \theta}}$$

λ = inelastic mean free path



Blob of C nanotubes



- Chemical inhomogeneity

Ni islands on Si

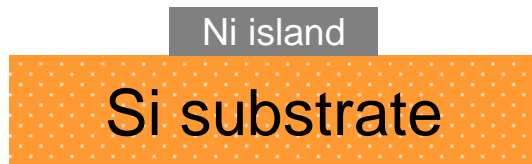


Image on Ni

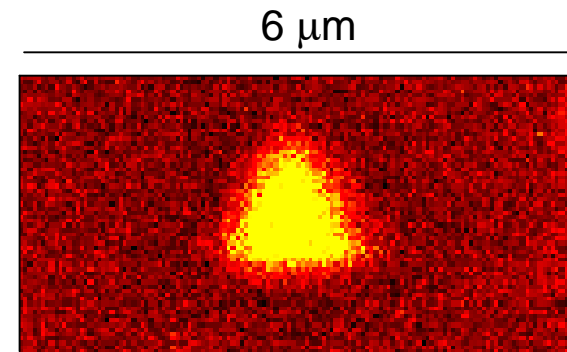
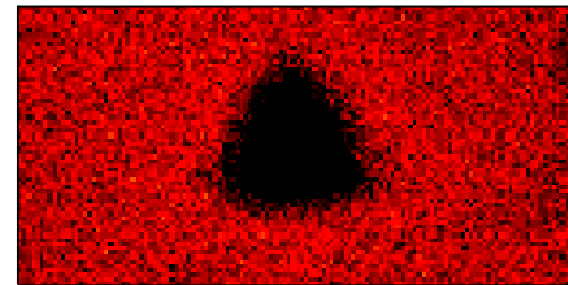


Image on Si



Au patch on Rh(110)



Image on Rh

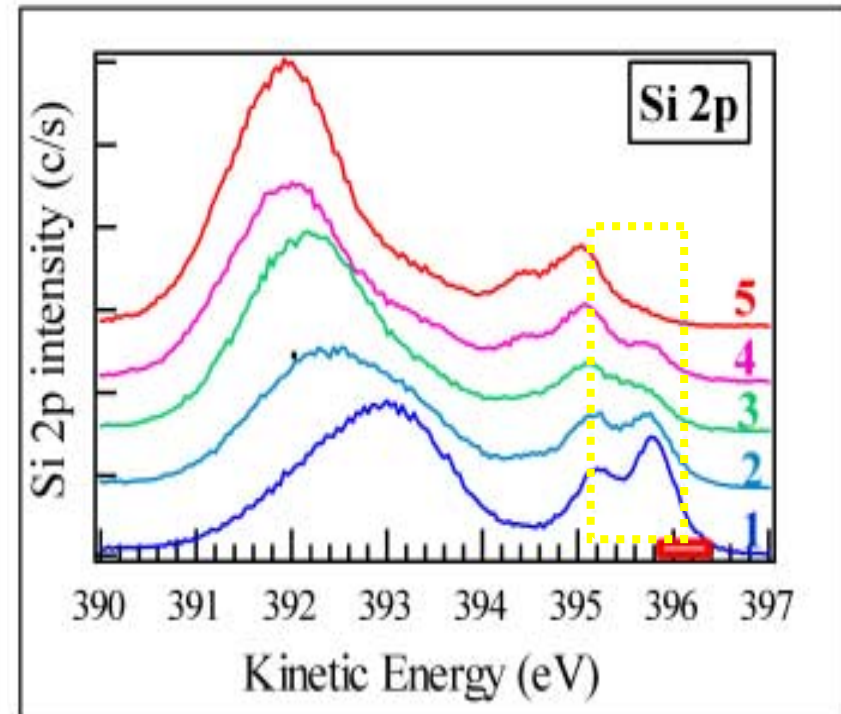
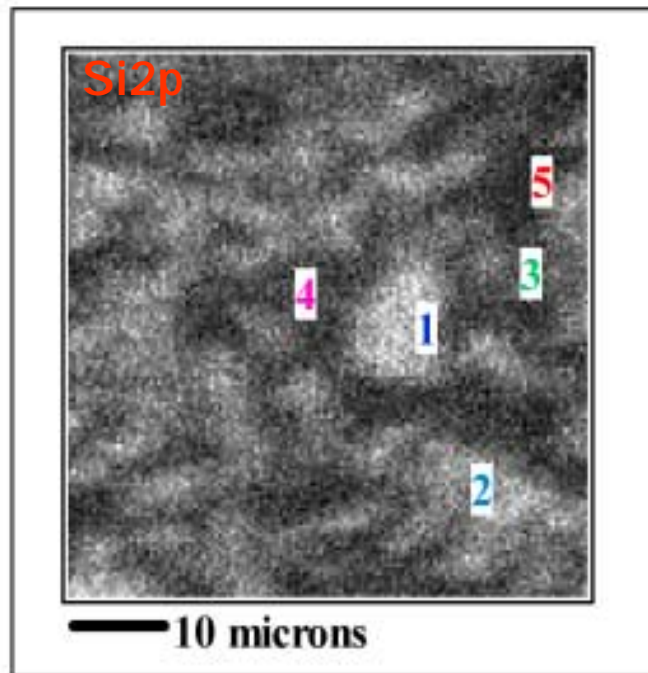


Image on Au



- Other sources of contrast

charging



Getting the chemical information out of the artefacts

Artefacts

1. Topography
2. Beam induced effects:
 - C deposition (residual gases)
 - O₂ reduction
 - Charging
3. Background level

General formulas:

$$I = \frac{I_{peak} - I_{bkg}}{I_{peak} + I_{bkg}}$$

$$I = \frac{I_{peak} - I_{bkg}}{I_{bkg}}$$

$$I = \frac{I_{peak}}{I_{bkg}}$$

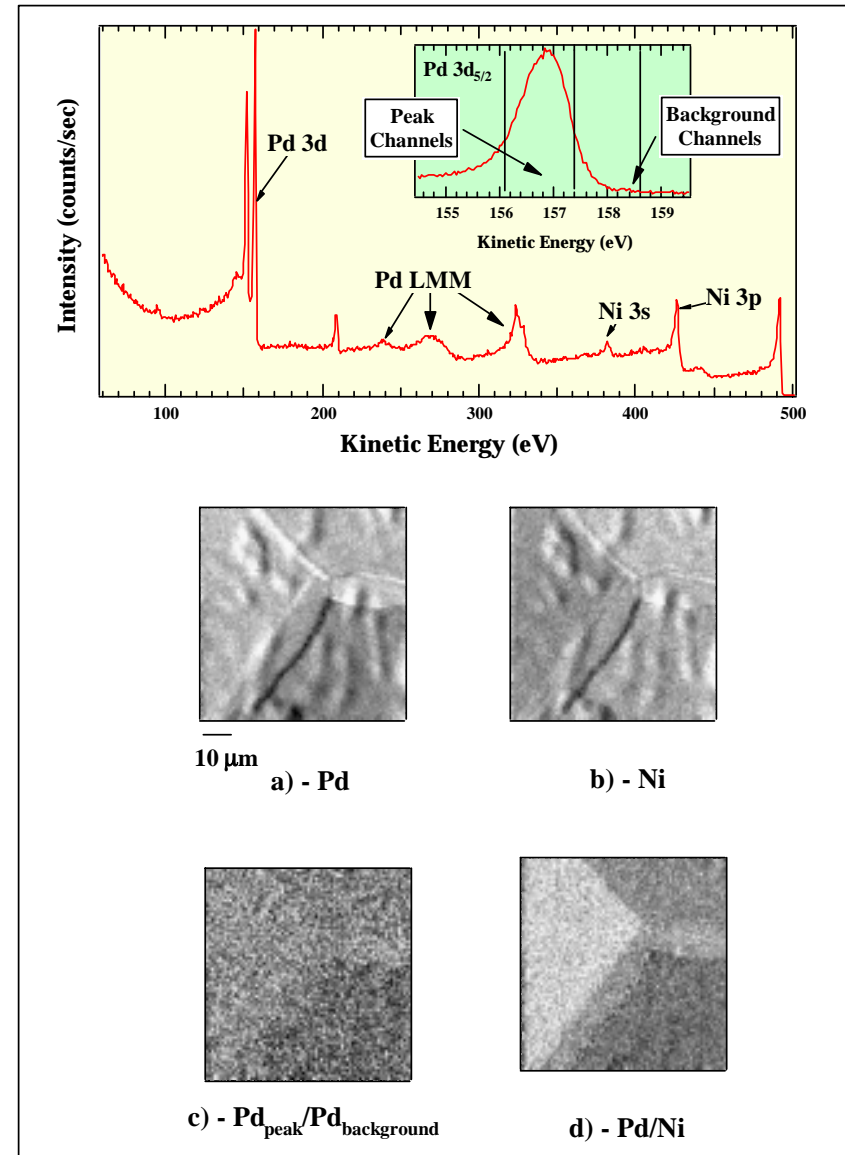
Which I_{bkg} ?

- I_{bkg} left
- I_{bkg} right
- I_{bkg} (left+right)
- *secondaries*

sometimes

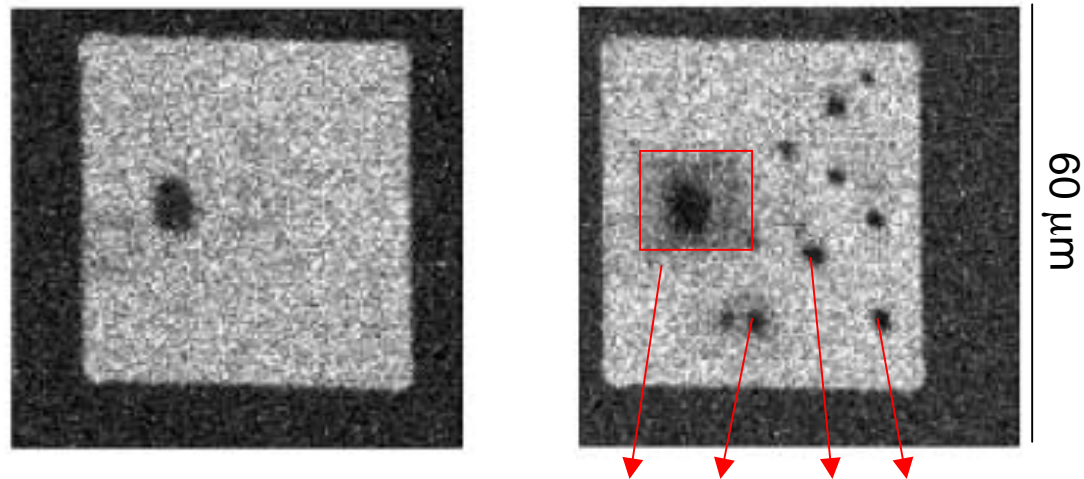
only:

$$\frac{I_{peak1}}{I_{peak2}}$$



C growth

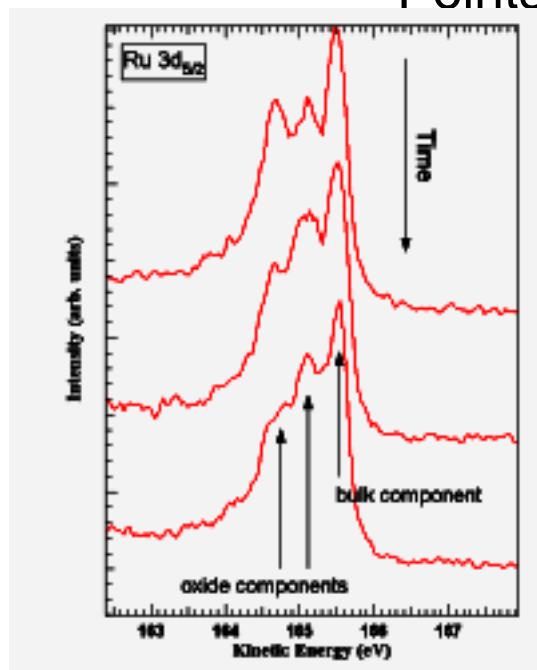
SiO_x sample
Si2p maps



Points irradiated (>10 min)

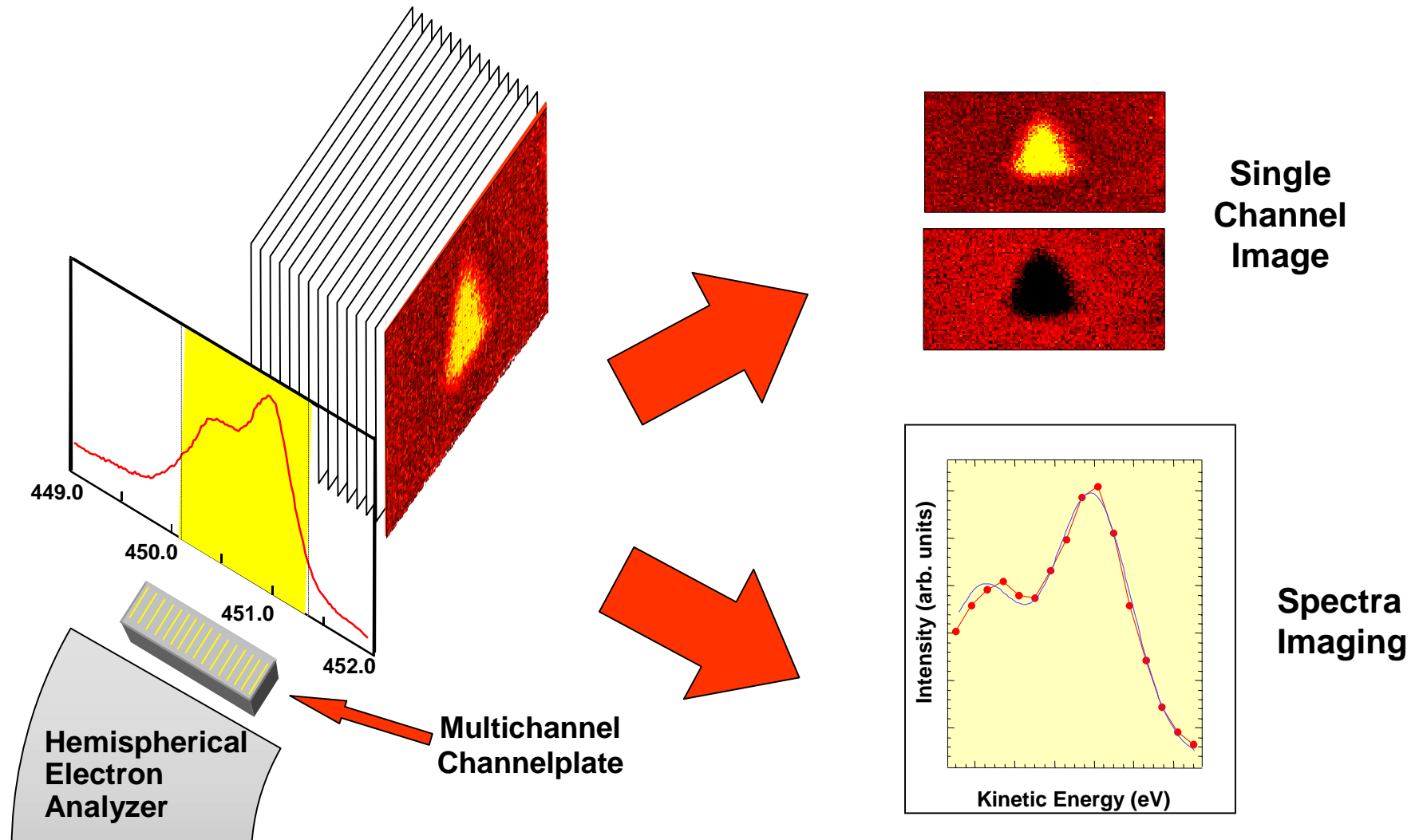
O₂ reduction

RuO_x sample



Each spectrum every 1 min

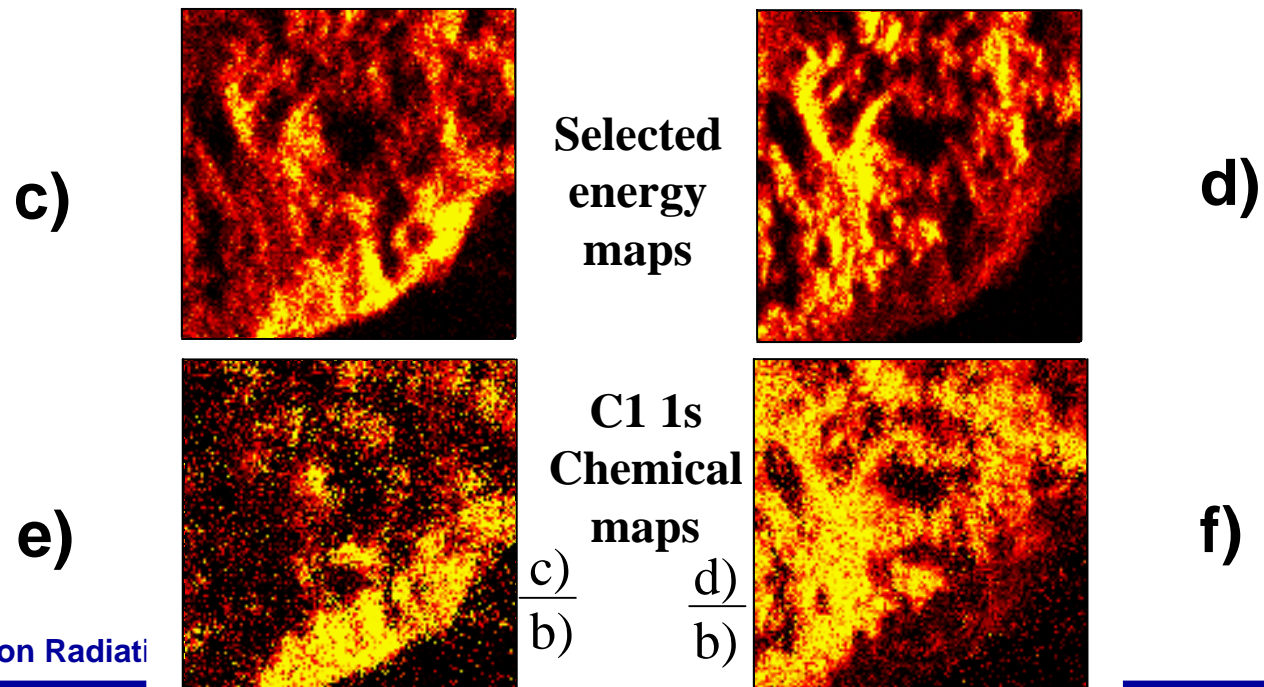
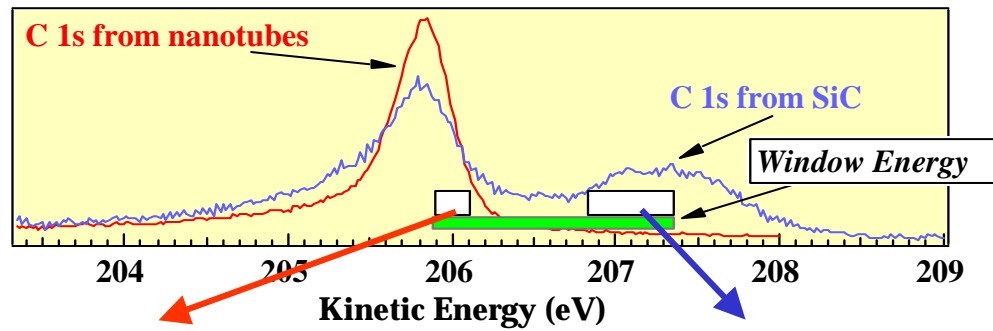
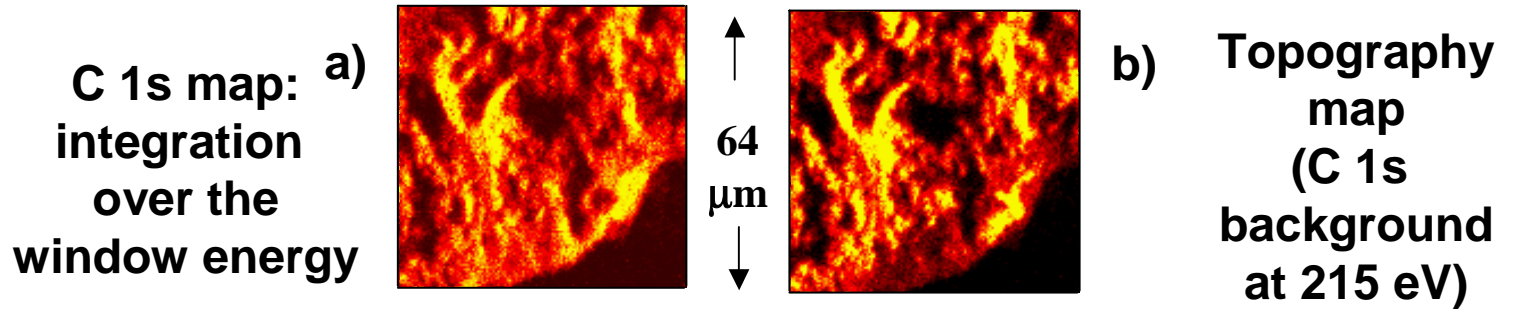
Multichannel detection



Single Channel Analysis

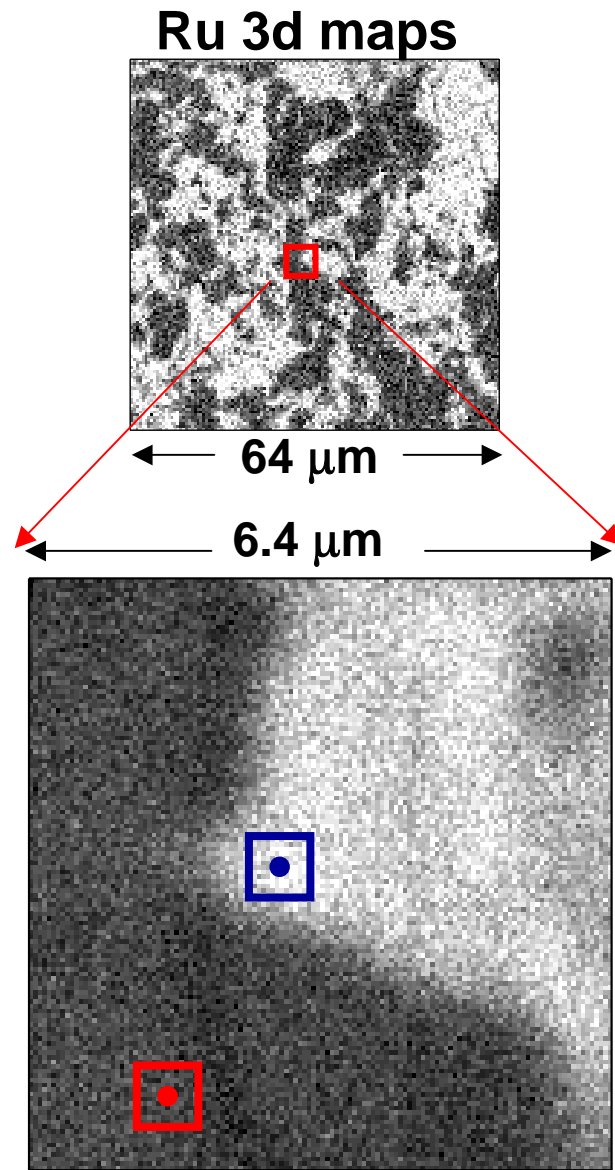
Carbon nanotubes on SiC

R. Larciprete – Enea - Italy



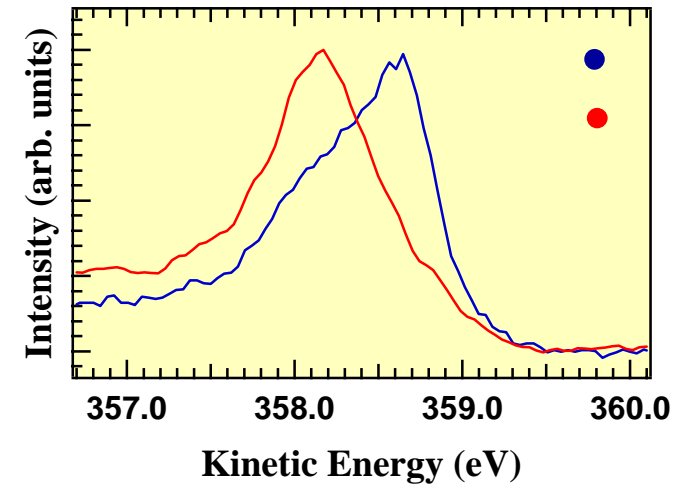
Spectra Imaging

Ru(0001) oxidation
H. Conrad – FHI - Germany

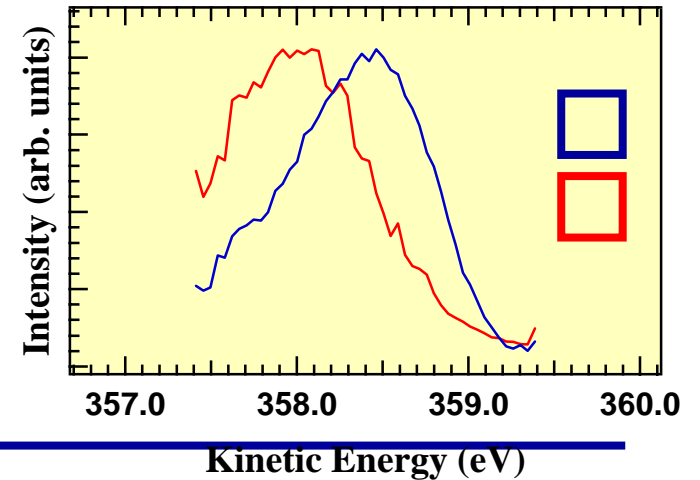


Ru 3d_{5/2} spectra

Conventional Scanning Spectroscopy (48 points - 70 sec)

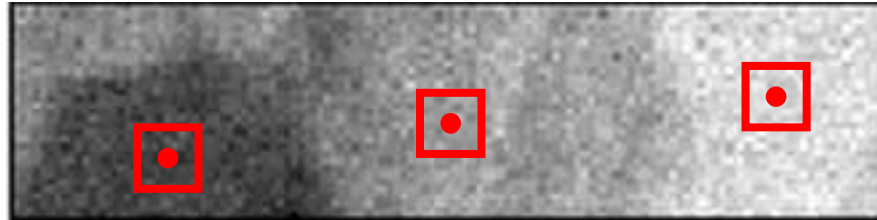


Inherent Dispersion Energy Spectroscopy (48 points - 10 sec)



Spectra Imaging

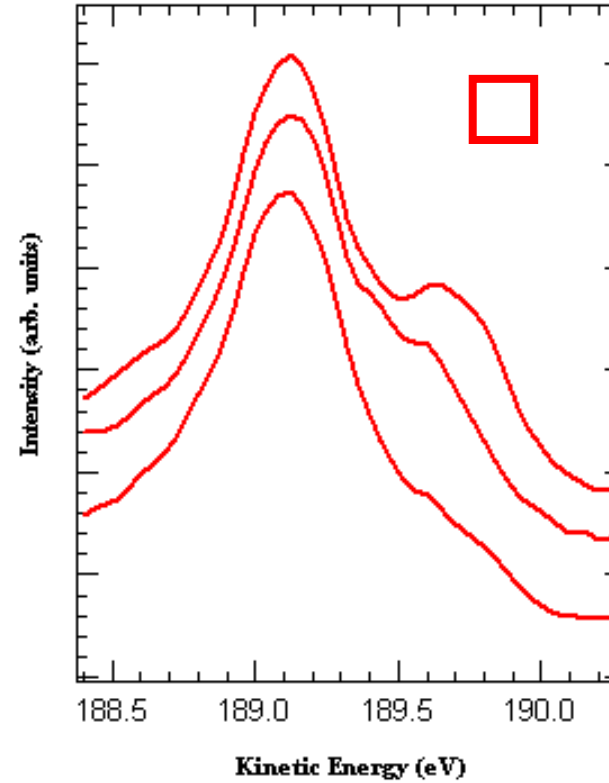
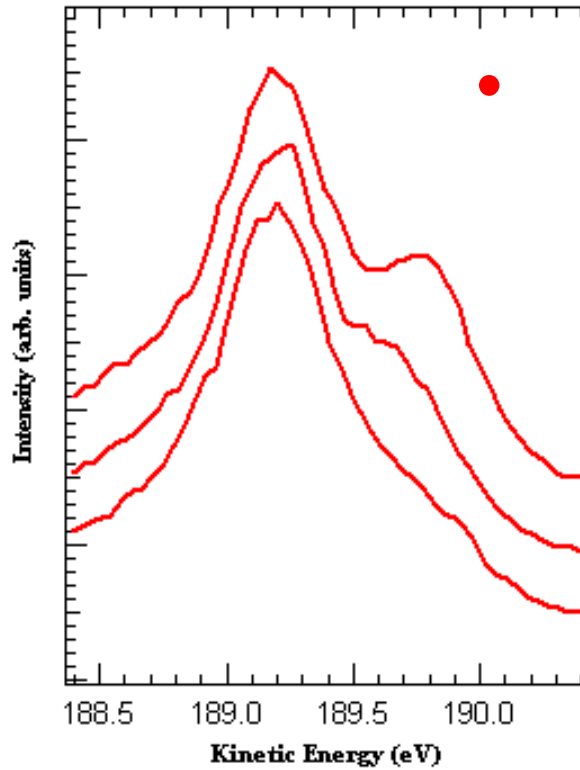
Rh 3d
map



Conventional Scanning Spectroscopy

Inherent Dispersion Energy Spectroscopy

Rh 3d_{3/2} spectra



Spectra analysis

Natural linewidth or core hole lifetime (Lorentzian)

Good for insulators and semiconductors

E_L = centroid
 Γ_L = FWHM

$$L(E) = \frac{1}{\left(1 + 4\left(\frac{E - E_L}{\Gamma_L}\right)^2\right)}$$

Instrumental resolution and phonon broadening (Gaussian)

$$G(E) = \exp\left[-4 \ln 2 \left(\frac{E - E_G}{\Gamma_G}\right)^2\right]$$

E_G = centroid
 Γ_G = FWHM

Convolution of the Gaussian and the Lorentzian (Voigt)

$$I(E_G) = \int_{-4\sigma}^{+4\sigma} \exp\left[-4 \ln(2) \left(\frac{E - E_G}{\Gamma_G}\right)^2\right] \times \frac{1}{\left(1 + 4\left(\frac{E - E_L}{\Gamma_L}\right)^2\right)} dE$$

Natural linewidth or
core hole lifetime
(Doniach-Sunjic)

$$DS(E) = \frac{\Gamma_L(1-\alpha) \cos \left[\frac{\pi\alpha}{2} + (1-\alpha) \arctan \left(2 \left(\frac{E-E_L}{\Gamma_L} \right) \right) \right]}{\left((E-E_L)^2 + \Gamma_L^2 \right)^{\frac{1-\alpha}{2}}}$$

Good for metals

E_L = centroid
 Γ_L = FWHM
 α = asymmetry

Lineshape for metals

$$I(E_G) = \int_{-4\sigma}^{+4\sigma} \exp \left[-4 \ln(2) \left(\frac{E-E_G}{\Gamma_G} \right)^2 \right] \times DS(E) dE$$

Fitting procedure

Background removal

Background functions:

•Tougaard
$$F(E) = j(E) - \lambda \int_E^{\infty} dE' K(E' - E) j(E')$$

$F(E)$ =primary excitation spectrum

$j(E)$ =flux of emitted electrons

$K(E,T)$ =probability for an electron of losing energy

λ =mean free path for inelastic scattering

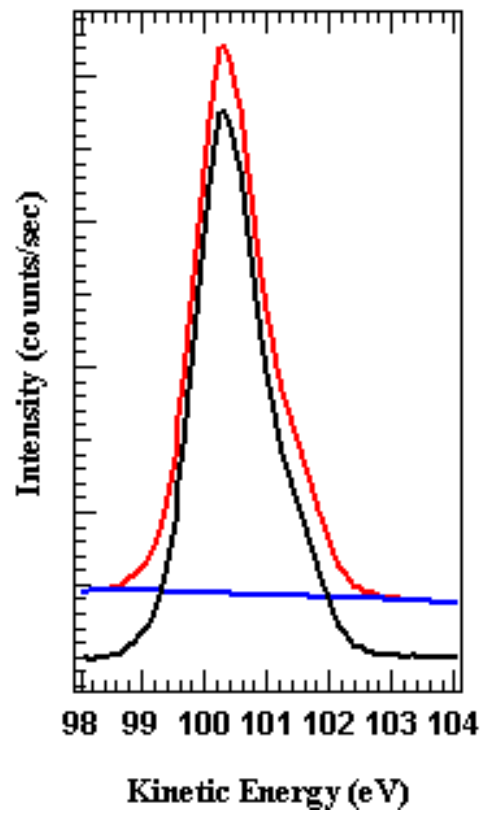
•Shirley
$$b_i = k \sum_{j=i+1}^N p_j$$

b_i =background of the point i
 p_j =signal of the point j
 N =highest kinetic energy
 k =constant

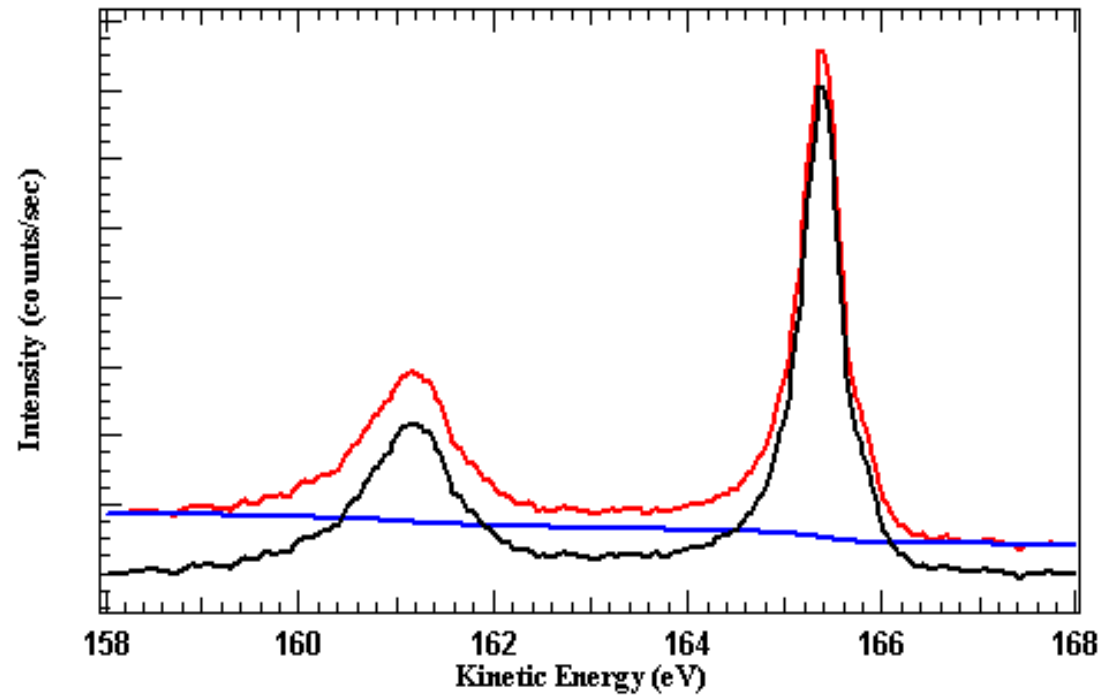
•Linear

•Cubic

Linear background: N1s



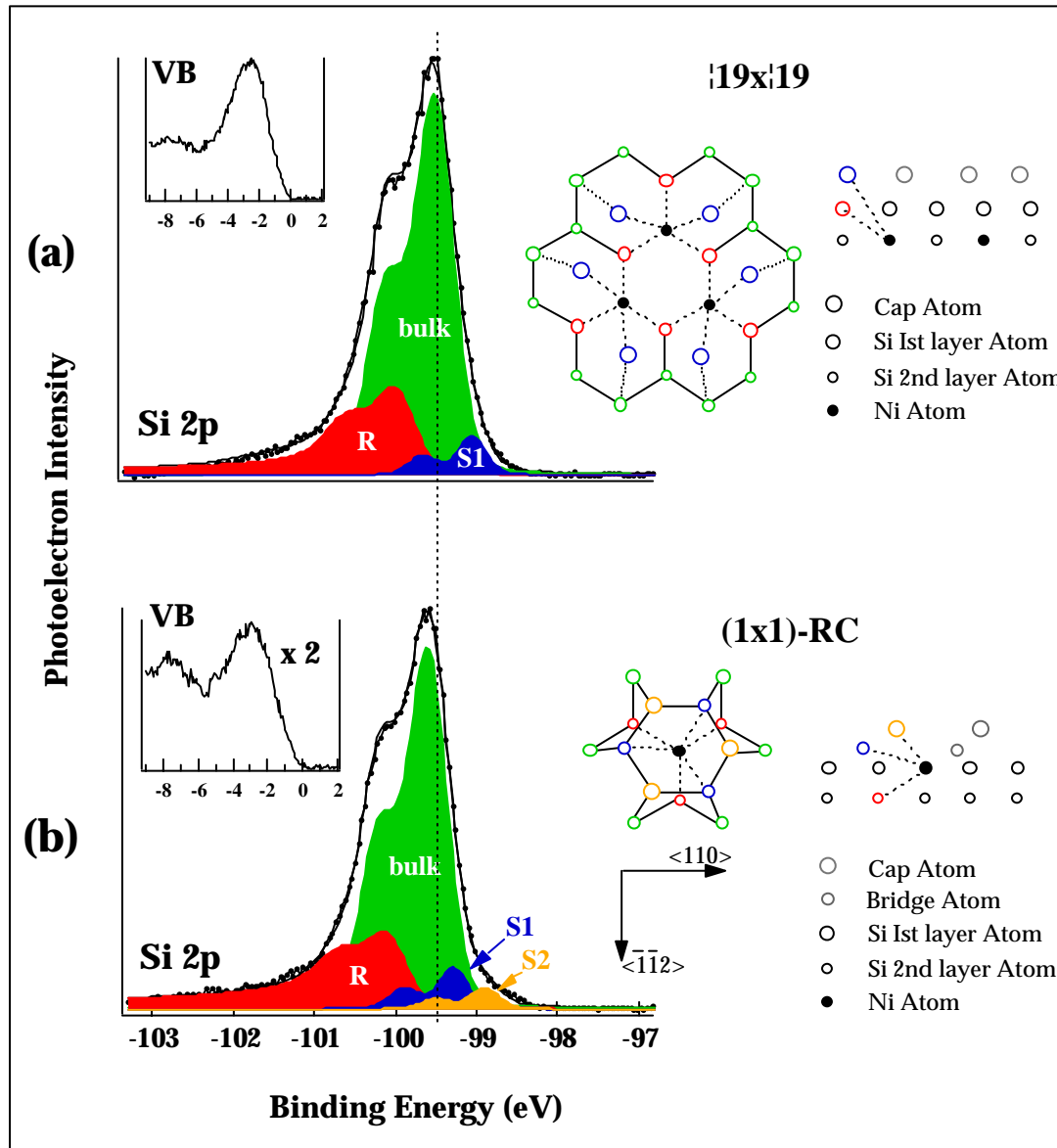
Shirley background: Rh3d



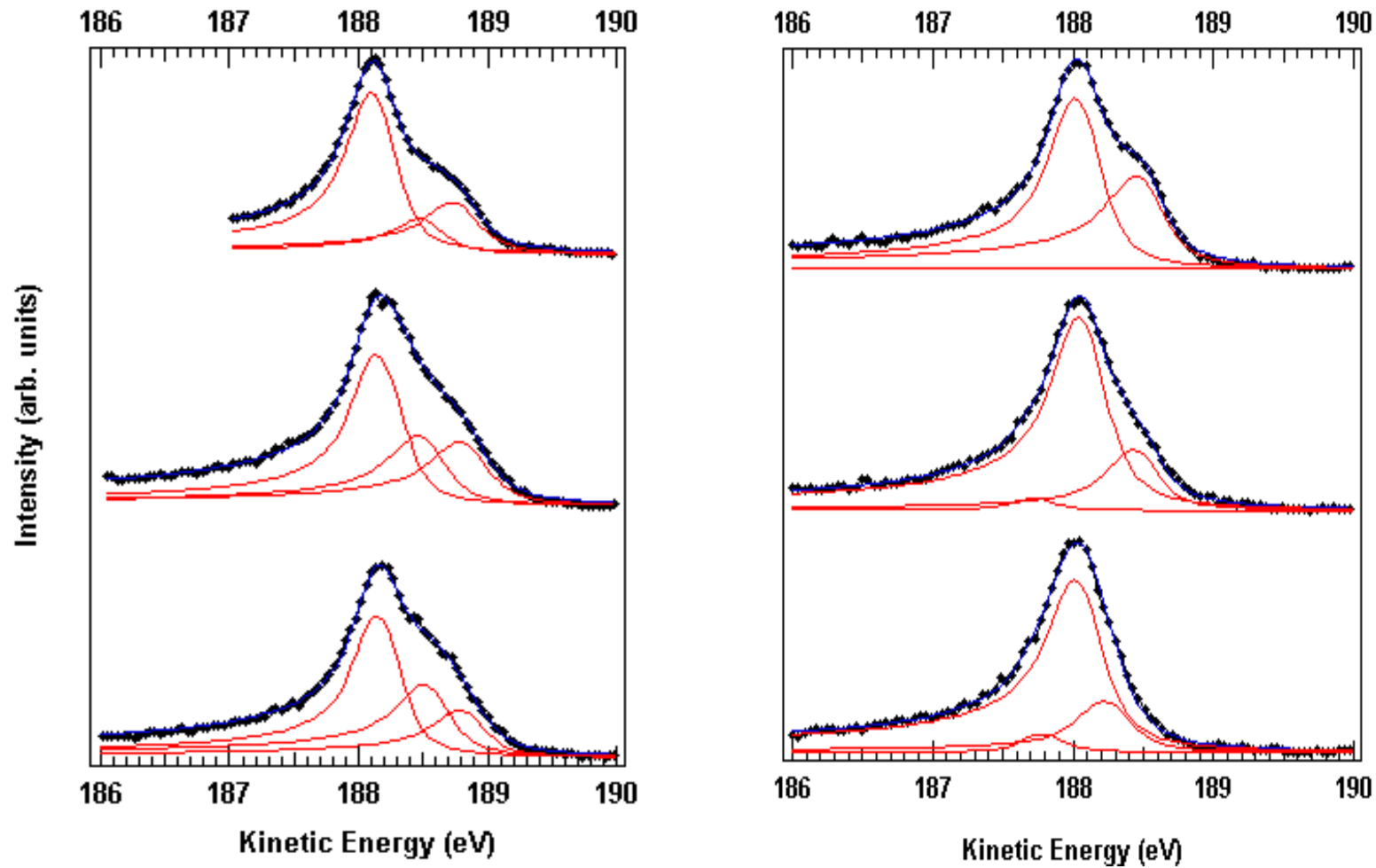
Fitting

Ni/Si(111)
2D reconstructions

Si2p
spectra



Rh $3d_{3/2}$ fitting procedure (same experiment)



References

S. Gunther, A. Kolmakov, J. Kovac, M. Kiskinova, "Artefact formation in scanning photoelectron emission microscopy", *Ultramicroscopy* 75 35-51, (1998).

J.J. Joice, M. Del Giudice and J. H. Weaver, "Quantitative analysis of synchrotron radiation photoemission core level data", *J. of Elec. Spectr. And Relat. Phenom.* 49 31-45 (1989).

Stefan Hufner, "Photoelectron spectroscopy, principles and applications", Springer